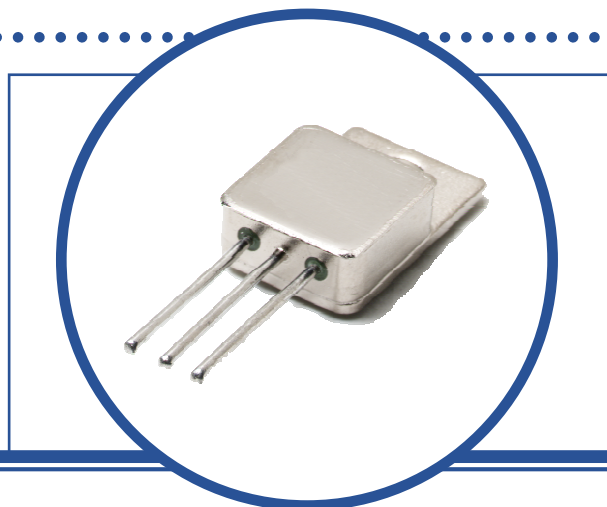


SILICON CARBIDE (SiC) SCHOTTKY DIODE

SML10SIC06YC

- Hermetic Metal TO-257AA Package.
- Semelab's Silicon Carbide (SiC) Schottky diodes exhibit low forward voltage and superb high temperature performance.
- Suitable for high-frequency hard switching applications, where system efficiency and reliability are paramount.
- No reverse recovery time due to absence of minority carrier injection.
- Screening Options Available.



ABSOLUTE MAXIMUM RATINGS (Per Diode, $T_C = 25^\circ\text{C}$ unless otherwise stated)

| | | |
|-----------|---|--------------------------------|
| V_R | DC Reverse Voltage | 600V |
| V_{RRM} | Repetitive Peak Reverse Voltage | 600V |
| I_F | DC Forward Current ($T_J = 175^\circ\text{C}$) | 10A |
| I_{FRM} | Repetitive Peak Forward Current ⁽¹⁾ | 67A |
| I_{FSM} | Surge Peak Forward Current ⁽²⁾ | 250A |
| P_D | Total Power Dissipation at Derate Above 25°C | 100W 0.5W/ $^\circ\text{C}$ |
| T_J | Junction Temperature Range | -55 to $+225^\circ\text{C}$ |
| T_{stg} | Storage Temperature Range | -55 to $+225^\circ\text{C}$ |

THERMAL PROPERTIES

| Symbols | Parameters | Max. | Units |
|-----------------|--------------------------------------|------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction To Case | 2.0 | $^\circ\text{C}/\text{W}$ |

Notes

(1) $T_c = 25^\circ\text{C}$, $T_p = 10\text{ms}$, Half Sine Wave, $D = 0.3$

(2) $T_c = 25^\circ\text{C}$, $T_p = 10\mu\text{s}$

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ELECTRICAL CHARACTERISTICS (Per Diode, $T_C = 25^\circ\text{C}$ unless otherwise stated)

Static Characteristics

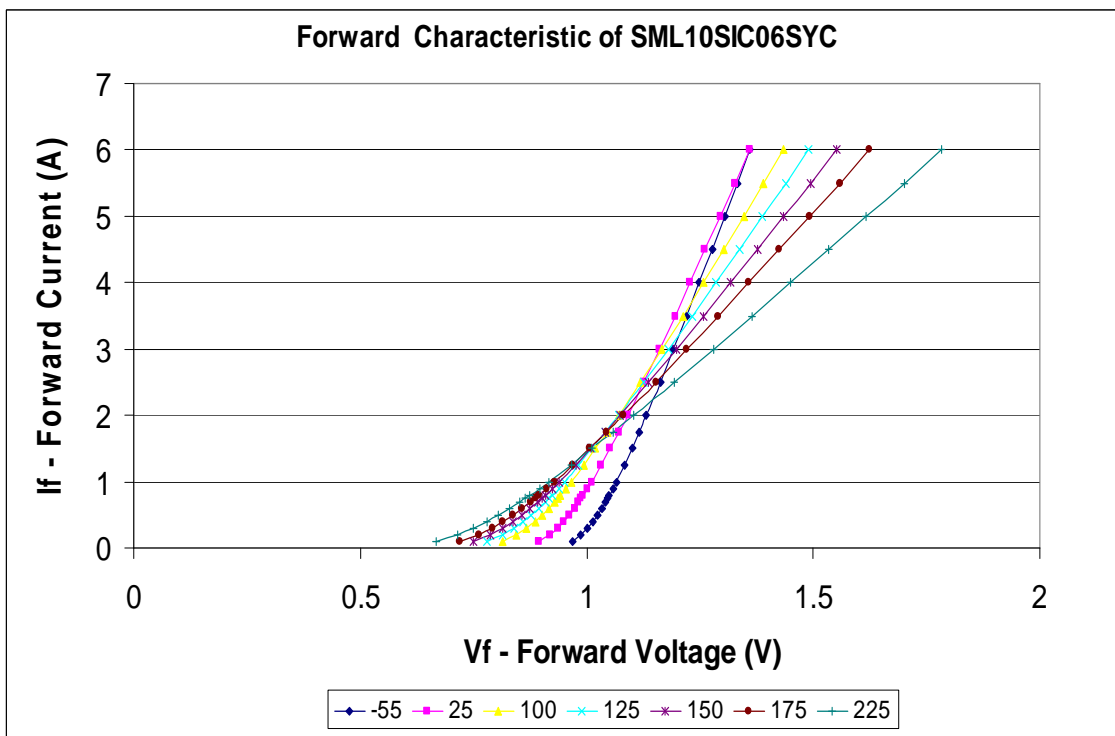
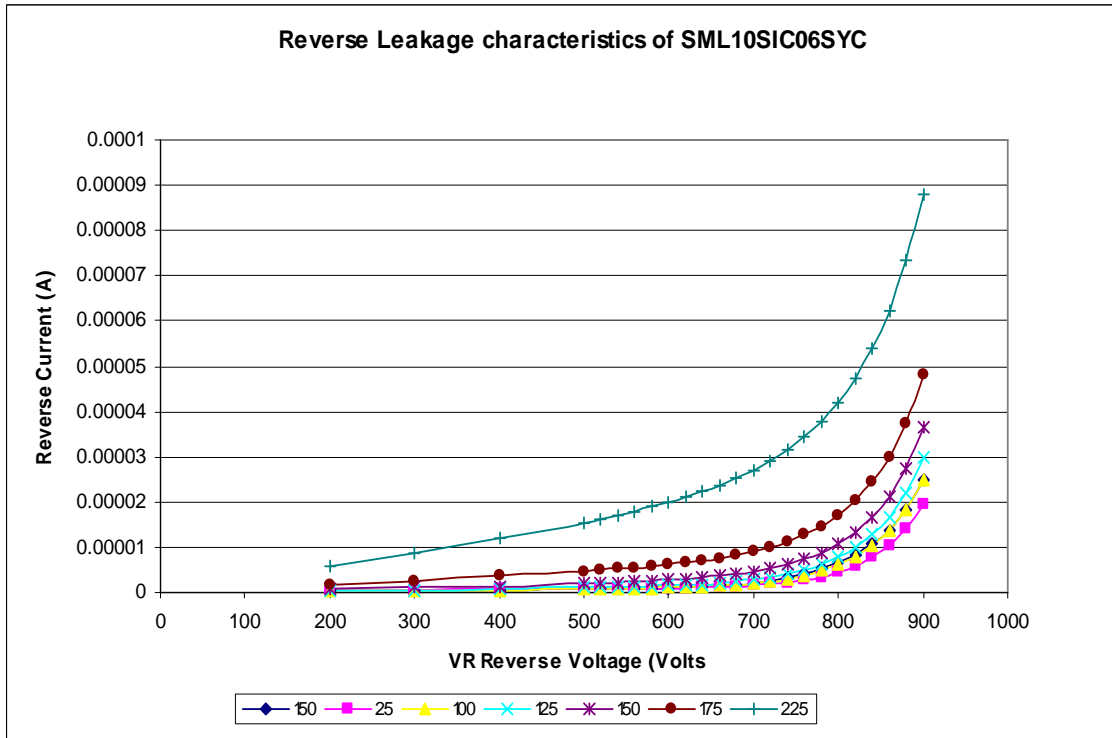
| Symbols | Parameters | Test Conditions | Min. | Typ. | Max. | Units |
|---------|-----------------|---------------------------|------|------|------|---------------|
| V_F | Forward Voltage | $I_F = 10\text{A}$ | | 1.5 | 1.8 | V |
| | | $T_J = 175^\circ\text{C}$ | | 2.0 | 2.4 | |
| I_R | Reverse Current | $V_R = 600\text{V}$ | | 10 | 50 | μA |
| | | $T_J = 175^\circ\text{C}$ | | 20 | 200 | |

Dynamic Characteristics

| | | | | | | |
|-------|-------------------------|---|--|-----|--|-------------|
| Q_C | Total Capacitive Charge | $V_R = 600\text{V}$, $I_F = 10\text{A}$ $\delta i/\delta t = 500\text{A}/\mu\text{s}$ | | 25 | | nC |
| C | Total Capacitance | $V_R = 1.0\text{V}$, $f = 1.0\text{MHz}$ | | 480 | | pF |
| | | $V_R = 200\text{V}$, $f = 1.0\text{MHz}$ | | 50 | | |
| | | $V_R = 400\text{V}$, $f = 1.0\text{MHz}$ | | 42 | | |

SILICON CARBIDE (SiC) SCHOTTKY DIODE SML10SIC06YC

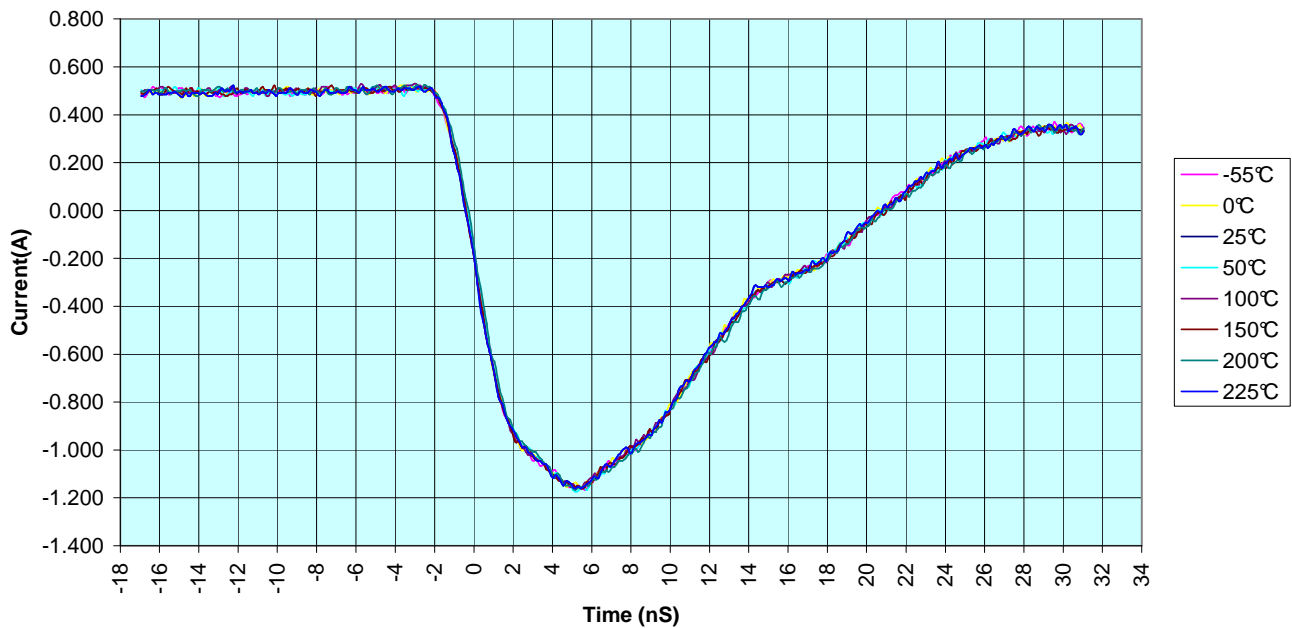
Typical Performance Over Temperature Range



SILICON CARBIDE (SiC) SCHOTTKY DIODE SML10SIC06YC

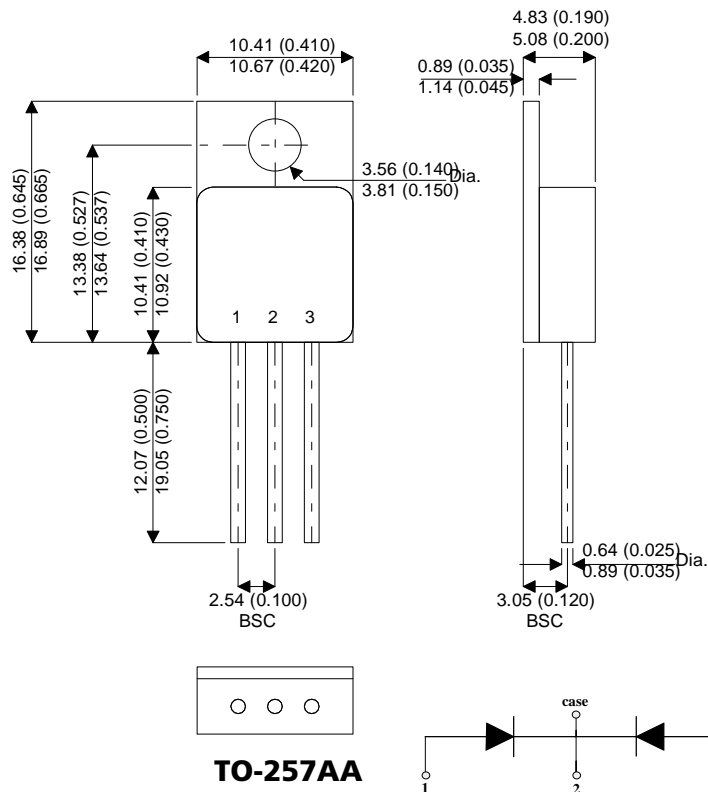
SiC Schottky Diode, no minority carrier recombination thus zero reverse recovery. Recovery time shown is due to a small junction capacitance charge and is independent of junction temperature

SML10SIC06YC
Equivalent Reverse Recovery Time Device
 $I_F=500\text{mA}$, $I_R = 1\text{A}$, $I_{RR}=250\text{mA}$



MECHANICAL DATA

Dimensions in mm (inches)



Pin 1 – Anode 1

Pin 2 – Case / Common Cathode

Pin 3 - Anode 2